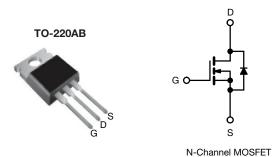


D Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	1.5		
Q _g max. (nC)	20			
Q _{gs} (nC)	3			
Q _{gd} (nC)	5			
Configuration	Single			

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- · Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF830BPbF			
Lead (Pb)-free and halogen-free	IRF830BPbF-BE3			

ABSOLUTE MAXIMUM RATINGS (To	c = 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	500		
Gate-source Voltage		V	± 30	V	
Gate-source voltage AC (f > 1 Hz)		V_{GS}	30	1	
Continuous drain current /T 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	5.3	А	
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 100 ^{\circ}\text{C}$		3.4		
Pulsed drain current ^a		I _{DM}	10		
Linear derating factor			0.83	W/°C	
Single pulse avalanche energy b	E _{AS}	28.8	mJ		
Maximum power dissipation	P _D	104	W		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C	4) / /d+	24	V/ns	
Reverse diode dV/dt ^d		dV/dt	0.28] v/fis	
Soldering recommendations (peak temperature) ^c	For 10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 5 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, starting $T_J = 25~^{\circ}C$



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	1.2	C/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Z	I _{DSS}	V _{DS} =	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	μА
Zero gate boltage drain current		V _{DS} = 400 V	V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.5 A	-	1.2	1.5	Ω
Forward transconductance a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$	-	325	-	
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	34	-]
Reverse transfer capacitance	C_{rss}		f = 1 MHz		6	-]
Effective output capacitance, energy related ^b	$C_{o(er)}$	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	31	-	pF
Effective output capacitance, time related ^c	$C_{o(tr)}$			-	41	-	
Total gate charge	Qg			-	10	20	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 2.5 \text{ A}, V_{DS} = 400 \text{ V}$		-	3	-	nC
Gate-drain charge	Q _{gd}			-	5	-	
Turn-on delay time	t _{d(on)}			-	12	24	
Rise time	t _r	$V_{DD} = 400 \text{ V}, I_{D} = 2.5 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	11	22	ns
Turn-off delay time	t _{d(off)}			-	14	28	
Fall time	t _f			-	11	22	
Gate input resistance	R_g	f = 1 MHz, open drain		0.8	1.7	3.4	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	
Pulsed diode forward current	I _{SM}			-	-	20	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	320	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25$	5 °C, I _F = I _S = 2.5 A, 100 A/μs, V _R = 20 V	-	1.2	-	μC
Reverse recovery current	I _{RRM}	u/ul =	100 AV µS, VR = 20 V	-	8	-	A

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

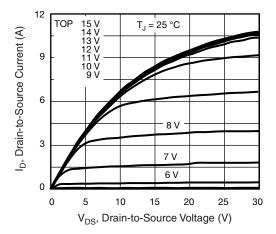


Fig. 1 - Typical Output Characteristics

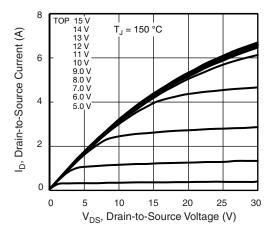


Fig. 2 - Typical Output Characteristics

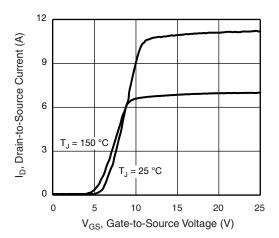


Fig. 3 - Typical Transfer Characteristics

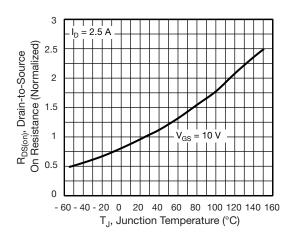


Fig. 4 - Normalized On-Resistance vs. Temperature

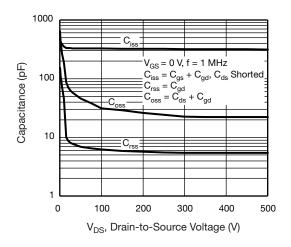


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

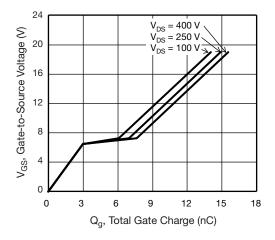


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



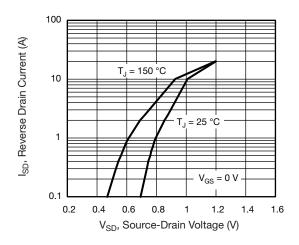


Fig. 7 - Typical Source-Drain Diode Forward Voltage

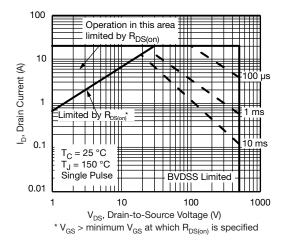


Fig. 8 - Maximum Safe Operating Area

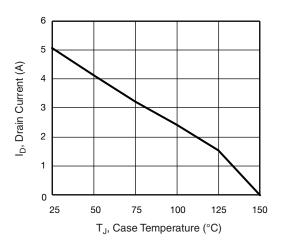


Fig. 9 - Maximum Drain Current vs. Case Temperature

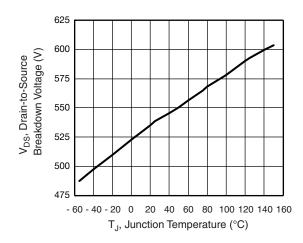


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

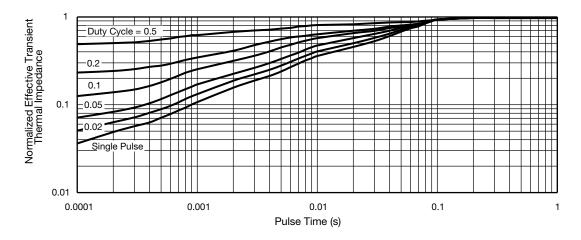


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



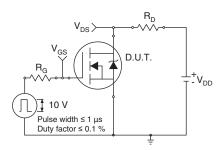


Fig. 12 - Switching Time Test Circuit

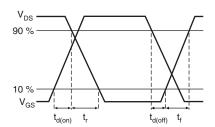


Fig. 13 - Switching Time Waveforms

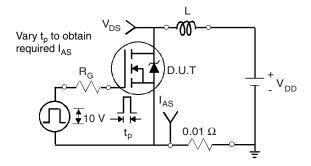


Fig. 14 - Unclamped Inductive Test Circuit

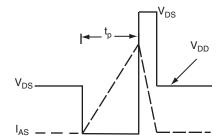


Fig. 15 - Unclamped Inductive Waveforms

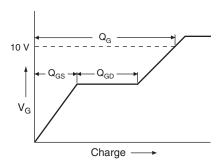


Fig. 16 - Basic Gate Charge Waveform

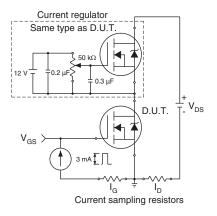
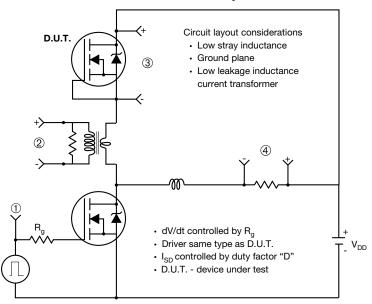


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



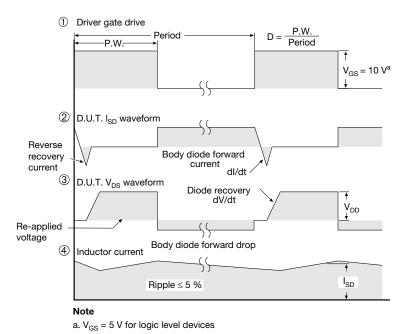
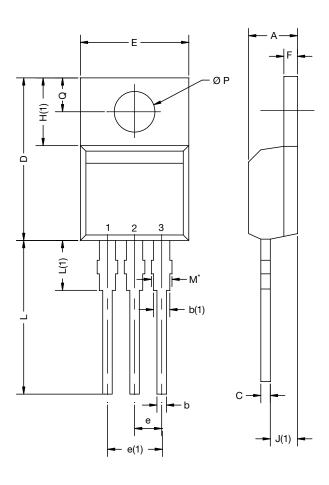


Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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